

RAD-TOLERANT CLASS V, HEX SCHMITT-TRIGGER INVERTER

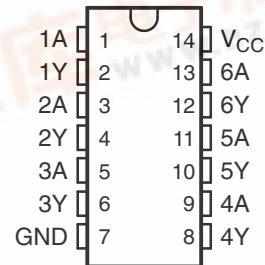
Check for Samples: [SN54AC14-SP](#)

FEATURES

- 2-V to 6-V V_{CC} Operation
- Inputs Accept Voltages to 6 V
- Max tpd of 9.5 ns at 5 V
- Rad-Tolerant: 50 kRad(Si) TID ⁽¹⁾
 - TID Dose Rate < 2mRad/sec
- QML-V Qualified, SMD 5962-87624

(1) Radiation tolerance is a typical value based upon initial device qualification. Radiation Lot Acceptance Testing is available - contact factory for details.

J OR W PACKAGE
(TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

These Schmitt-trigger devices contain six independent inverters. They perform the Boolean function $Y = \bar{A}$. Because of the Schmitt action, they have different input threshold levels for positive-going (V_{T+}) and for negative-going (V_{T-}) signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean, jitter-free output signals. They also have a greater noise margin than conventional inverters.

ORDERING INFORMATION⁽¹⁾

T_A	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-55°C to 125°C	CDIP – J	Tube	5962-8762402VCA	5962-8762402VCA
	CFP – W	Tube	5962-8762402VDA	5962-8762402VDA

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
 (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

FUNCTION TABLE (EACH INVERTER)

INPUT A	OUTPUT Y
H	L
L	H

LOGIC DIAGRAM, EACH INVERTER (POSITIVE LOGIC)



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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Supply voltage range	–0.5	7	V
V_I	Input voltage range ⁽²⁾	–0.5	$V_{CC} + 0.5$	V
V_O	Output voltage range ⁽²⁾	–0.5	$V_{CC} + 0.5$	V
I_{IK}	Input clamp current	$V_I < 0$ or $V_I > V_{CC}$		±20 mA
I_{OK}	Output clamp current	$V_O < 0$		±20 mA
I_O	Continuous output current	$V_O = 0$ to V_{CC}		±50 mA
	Continuous current through V_{CC} or GND			±200 mA
T_{stg}	Storage temperature range	–65	150	°C

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded provided the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

		MIN	MAX	UNIT
V _{CC}	Supply voltage	2	6	V
V _I	Input voltage	0	V _{CC}	V
V _O	Output voltage	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 3 V	−12	mA
		V _{CC} = 4.5 V	−24	
		V _{CC} = 5.5 V	−24	
I _{OL}	Low-level output current	V _{CC} = 3 V	12	mA
		V _{CC} = 4.5 V	24	
		V _{CC} = 5.5 V	24	
T _A	Operating free-air temperature	−55	125	°C

- (1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C		T _A = –55°C TO 125°C		UNIT
			MIN	MAX	MIN	MAX	
V _{T+} Positive-going threshold		3 V		2.3		2.3	V
		4.5 V		3.2		3.2	
		5.5 V		3.9		3.9	
V _{T–} Negative-going threshold		3 V	0.5		0.5		V
		4.5 V	0.9		0.9		
		5.5 V	1.1		1.1		
ΔV_T Hysteresis (V _{T+} – V _{T–})		3 V	0.3	1.3	0.3	1.3	V
		4.5 V	0.4	1.4	0.4	1.4	
		5.5 V	0.5	1.6	0.5	1.6	
V _{OH}	I _{OH} = –50 μ A	3 V		2.9		2.9	V
		4.5 V		4.4		4.4	
		5.5 V		5.4		5.4	
	I _{OH} = –12 mA	3 V		2.56		2.4	
		4.5 V		3.86		3.7	
	I _{OH} = –24 mA	4.5 V		3.86		3.7	
		5.5 V		4.86		4.7	
	I _{OH} = –50 mA ⁽¹⁾	5.5 V				3.85	
V _{OL}	I _{OL} = 50 μ A	3 V		0.1		0.1	V
		4.5 V		0.1		0.1	
		5.5 V		0.1		0.1	
	I _{OL} = 12 mA	3 V		0.5		0.5	
		4.5 V		0.5		0.5	
	I _{OL} = 24 mA	4.5 V		0.5		0.5	
		5.5 V		0.5		0.5	
	I _{OL} = 50 mA ⁽¹⁾	5.5 V				1.65	
I _I	V _I = V _{CC} or GND	5.5 V		±0.1		±1	μ A
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V		4		80	μ A
C _i	V _I = V _{CC} or GND	5 V		8		8	pF

(1) Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			$T_A = -55^\circ\text{C}$ TO 125°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH}	A	Y	1.5	6	13.5	1	16	ns
t_{PHL}			1.5	6	11.5	1	14	

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see [Figure 1](#))

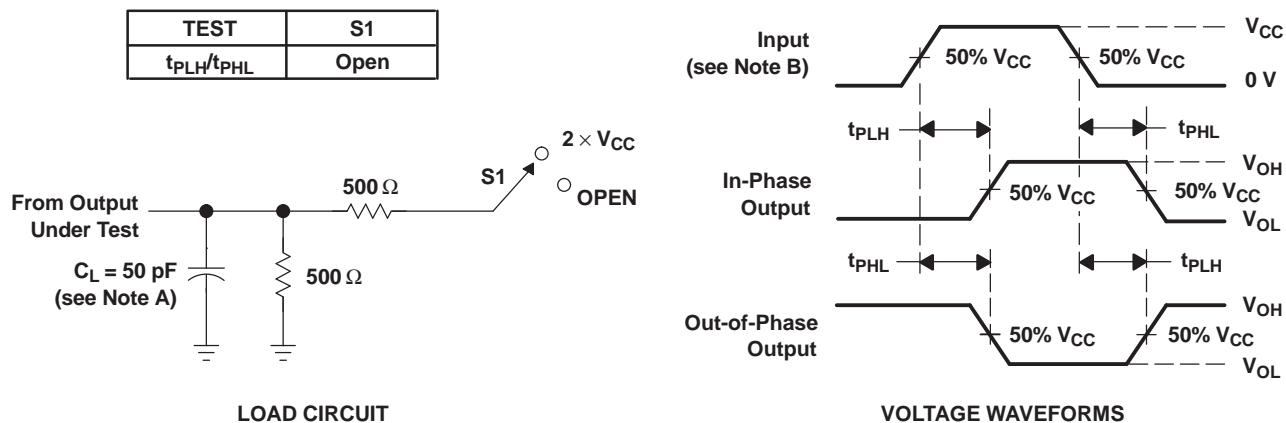
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			-55°C TO 125°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH}	A	Y	1.5	5	10	1.5	12	ns
t_{PHL}			1.5	5	8.5	1.5	10	

OPERATING CHARACTERISTICS

$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	$C_L = 50\text{ pF}$, $f = 1\text{ MHz}$	25	pF

PARAMETER MEASUREMENT INFORMATION



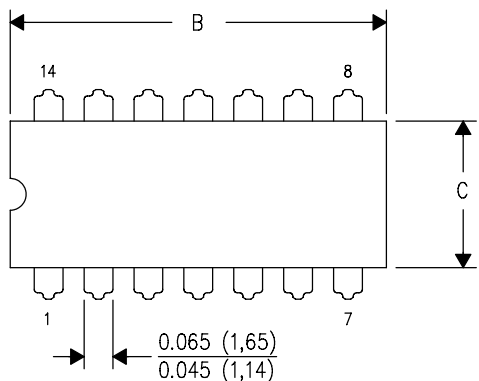
- NOTES: A. C_L includes probe and jig capacitance.
 B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

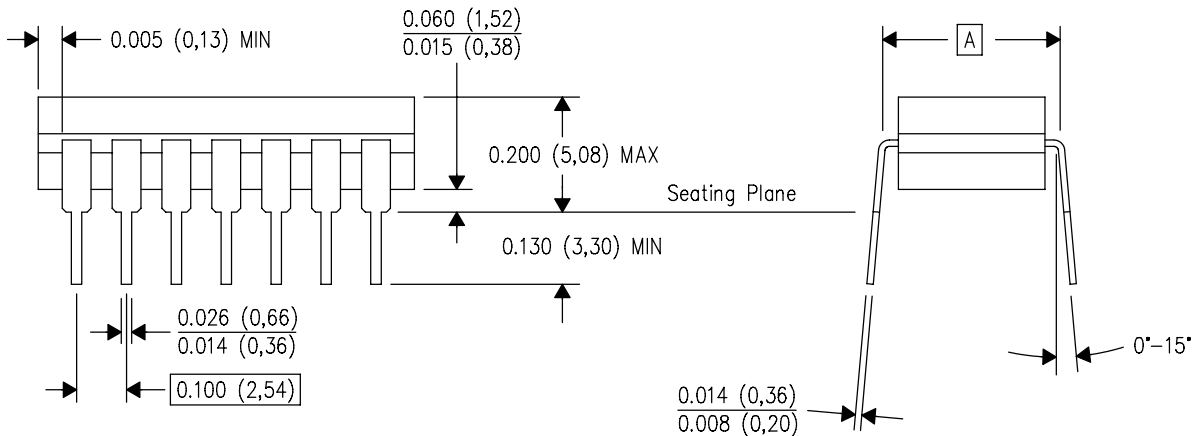
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

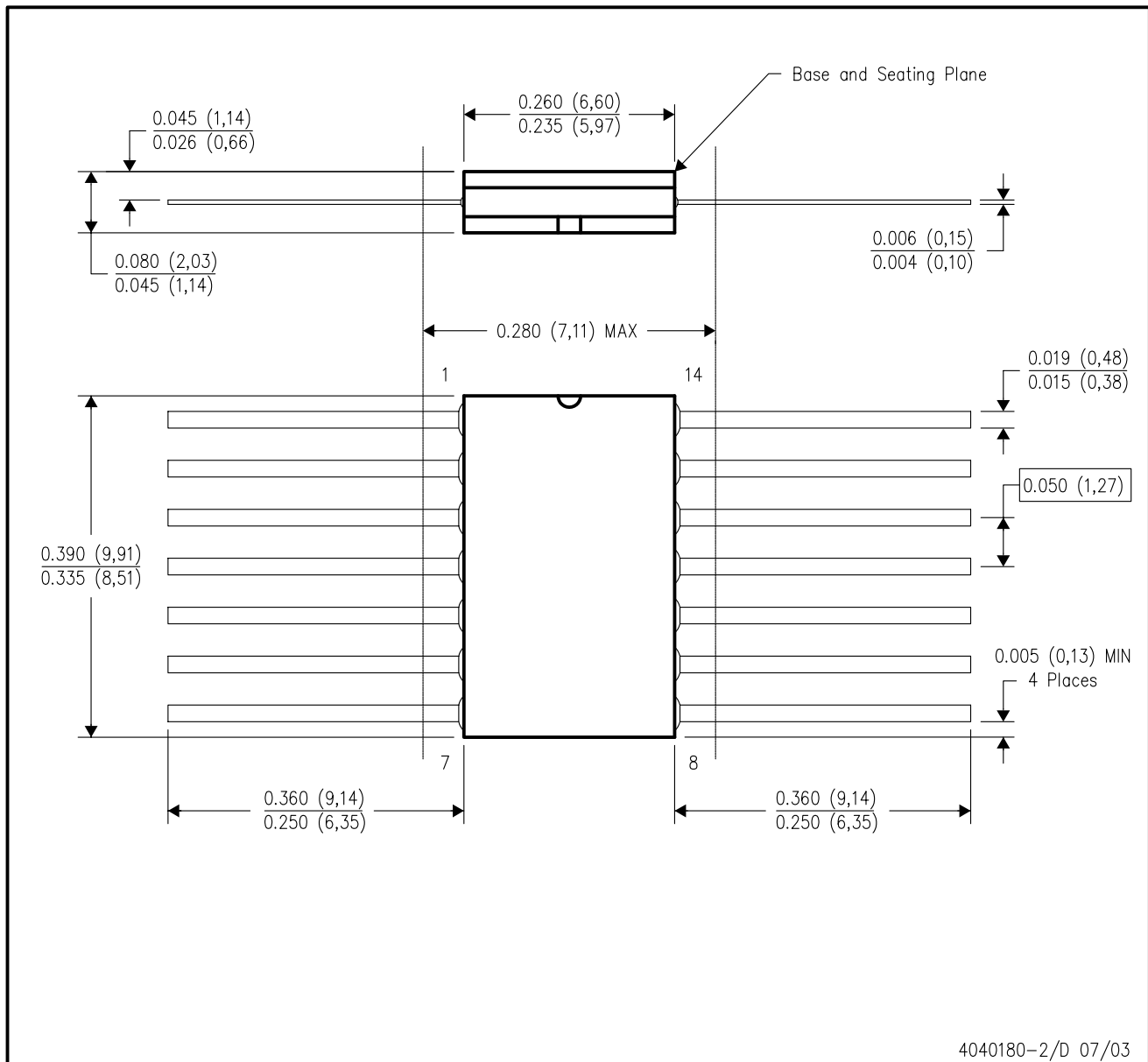


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- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

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